

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	"520923" and kamitake	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 08:01
L2	2	"5608267".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 08:03
L3	2	"5753529".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 08:04
L4	2	"4680618".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 08:26
L5	0	(semiconductor chip die) with (hard with carbin) with (copper cu) with (tungsten w) with (mo)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 08:30
L6	0	(semiconductor chip die) same (hard with carbin) same (copper cu) same (tungsten w) same (mo)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 08:30
L7	0	(semiconductor chip die) same (hard with carbin) same (copper cu) same (tungsten w) same (mo)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 08:31
L8	0	(semiconductor chip die ic flipchip (flip adj chip)) same (hard with carbin) same (copper cu) same (tungsten w) same (mo)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 08:31

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L9	13	(semiconductor chip die ic flipchip (flip adj chip)) same (hard with carbon) same (copper cu) same (tungsten w) same (mo)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 08:35
L10	583	(semiconductor chip die ic flipchip (flip adj chip)) and (hard with carbon) and (copper cu) and (tungsten w) and (mo)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 08:35
L11	570	10 not 9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/02 08:36